

• •	INDUSTRY A.
Date:	May 16, 1995
Reference:	Standards Proposal No. 3389, Proposed New Standard "PCS 1900 Air Interface Specification" (if approved, to be published as J-STD-007)
Company Name:	Hitachi Telecom (USA), Inc.
Address:	3617 Parkway Lane
	Norcross, GA 30092
Contact Person Re	garding Patents and Intellectual Property Matters:
	Michael Medin
	(Name Printed)
٠.	Title: Director - Systems Engineering

On behalf of the above company, and being authorized by the company to make such representations, we indicate the following:

Telephone and FAX: (T) 770-446-8820

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Agr	reed, on behalf of the above Company: Muchael W Mudm (Signature)
	Name (printed): Michael Medin Date: 7/14/95